

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Gurtej S. Sandhu

Serial No.: 09/023,146

Filed: February 12, 1998

For: TUNGSTEN SILICIDE (WSIX)
DEPOSITION PROCESS FOR
SEMICONDUCTOR MANUFACTURE

Confirmation No.: 6553

Examiner: W. Coleman

Group Art Unit: 2823

Attorney Docket No.: 2269-3369.1US
(91-365RE)

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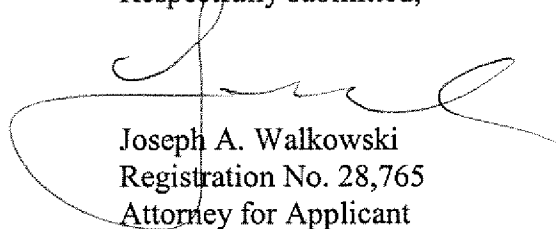
Sir:

1. This letter is to specify that the FEE ADDRESSEE for this patent is:

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2. The Customer Number for the Fee Addressee is **26809**.
3. Any prior FEE ADDRESSEE for this patent is hereby revoked.
4. It is certified that the person whose signature appears below has the authority to change the FEE ADDRESSEE for this patent.

Respectfully submitted,



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Date: June 5, 2007
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